

## PS9821-1,-2

HIGH CMR, 15 Mbps OPEN COLLECTOR OUTPUT TYPE 8-PIN SSOP (SO-8) 3.3 V HIGH-SPEED PHOTOCOUPLER

R08DS0260EJ0100 Rev.1.00 Dec 17, 2021

#### **DESCRIPTION**

The PS9821-1 and PS9821-2 are active-low type high-speed photocouplers that use an AlGaAs light-emitting diode on the input side and a photodetector IC that includes a photodiode and a signal processor on the same chip on the output side.

The PS9821-1, -2 are designed specifically for high common mode transient immunity (CMR) and low pulse width distortion, PS9821-2 is suitable for high density applications.

#### **FEATURES**

- Low power consumption (Vcc = 3.3 V)
- Pulse width distortion ( $|t_{PHL}-t_{PLH}| = 35 \text{ ns MAX.}$ )
- High common mode transient immunity (CM<sub>H</sub>, CM<sub>L</sub> =  $\pm 15$  kV/ $\mu$ s MIN.)
- 40% reduction of mounting area (5-pin SOP × 2)
- High-speed (15 Mbps)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- Open collector output
- Ordering number of tape product: PS9821-1-F3 : 1 500 pcs/reel

: PS9821-2-F3 : 1 500 pcs/reel

- Pb-Free product
- Safety standards
  - UL : UL1577, Single protection
  - CSA: CAN/CSA-C22.2 No.62368-1, Basic insulation
  - VDE : DIN EN 60747-5-5 (Option)

## PIN CONNECTION (Top View) PS9821-1 1. NC 2. Anode 3. Cathode 4. NC 5. GND 6. V<sub>O</sub> 7. NC $8. V_{CC}$ PS9821-2 1. Anode1 2. Cathode1 3. Cathode2 4. Anode2 5. GND 6. V<sub>O2</sub> $7.\;V_{O1}$ 8. V<sub>CC</sub>

### **APPLICATIONS**

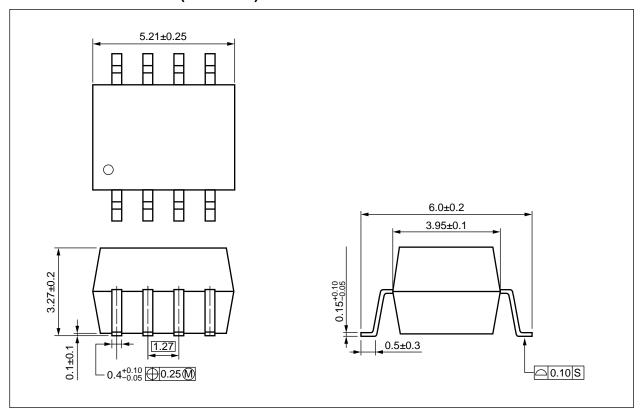
- Measurement equipment
- PDP
- FA Network

### TRUTH TABLE

| LED | Output |
|-----|--------|
| ON  | L      |
| OFF | Н      |

Start of mass production Sep.2004

## PACKAGE DIMENSIONS (UNIT: mm)



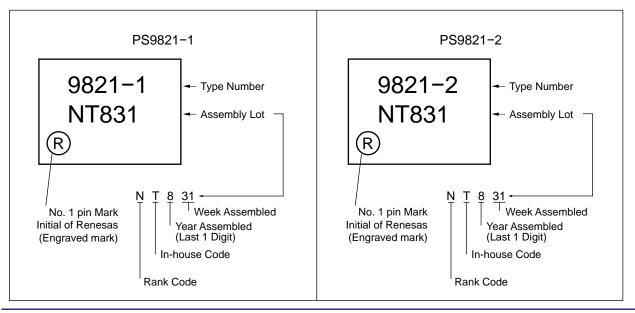
Weight: 0.14g (typ.)

## PHOTOCOUPLER CONSTRUCTION

| Parameter          | Unit (MIN.) |
|--------------------|-------------|
| Air Distance       | 4 mm        |
| Creepage Distance  | 4 mm        |
| Isolation Distance | 0.2 mm      |

### **MARKING EXAMPLE**

Ni/Pd/Au PLATING



R08DS0260EJ0100 Rev.1.00

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### **ORDERING INFORMATION**

| Part Number   | Order Number     | Solder Plating<br>Specification | Packing Style                | Safety Standard<br>Approval  | Application Part Number*1 |
|---------------|------------------|---------------------------------|------------------------------|------------------------------|---------------------------|
| PS9821-1      | PS9821-1-AX      | Pb-Free                         | 20 pcs (Tape 20 pcs cut)     | Standard products            | PS9821-1                  |
| PS9821-1-F3   | PS9821-1-F3-AX   | (Ni/Pd/Au)                      | Embossed Tape 1 500 pcs/reel | (UL, CSA                     |                           |
| PS9821-2      | PS9821-2-AX      |                                 | 20 pcs (Tape 20 pcs cut)     | - approved)                  | PS9821-2                  |
| PS9821-2-F3   | PS9821-2-F3-AX   |                                 | Embossed Tape 1 500 pcs/reel |                              |                           |
| PS9821-1-V    | PS9821-1-V-AX    |                                 | 20 pcs (Tape 20 pcs cut)     | UL, CSA,                     | PS9821-1                  |
| PS9821-1-V-F3 | PS9821-1-V-F3-AX |                                 | Embossed Tape 1 500 pcs/reel | DIN EN 60747-5-5<br>approved |                           |
| PS9821-2-V    | PS9821-2-V-AX    |                                 | 20 pcs (Tape 20 pcs cut)     | арргочес                     | PS9821-2                  |
| PS9821-2-V-F3 | PS9821-2-V-F3-AX |                                 | Embossed Tape 1 500 pcs/reel |                              |                           |

Notes\*: 1. For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise specified)

| Parameter   |                      | Symbol           | Ra            | Unit             |         |
|-------------|----------------------|------------------|---------------|------------------|---------|
|             |                      |                  | PS9821-1      | PS9821-2         |         |
| Diode       | Forward Current      | lf               | 20*1          | 15 <sup>*2</sup> | mA      |
|             | Reverse Voltage      | V <sub>R</sub>   |               | 5                | V/ch    |
| Detector    | Supply Voltage       | Vcc              |               | 7                | V       |
|             | Output Voltage       | Vo               | 7             |                  | V/ch    |
|             | Output Current       | lo               | 25            |                  | mA/ch   |
|             | Power Dissipation *3 | Pc               | 40            |                  | mW/ch   |
| Isolation V | oltage *4            | BV               | 2 500         |                  | Vr.m.s. |
| Operating   | Ambient Temperature  | TA               | - 40 to + 85  |                  | °C      |
| Storage T   | emperature           | T <sub>stg</sub> | - 55 to + 125 |                  | °C      |

Notes\*: 1. Reduced to 0.3 mA/ $^{\circ}$ C at T<sub>A</sub> = 60  $^{\circ}$ C or more.

- 2. Reduced to 0.1 mA/ $^{\circ}$ C at T<sub>A</sub> = 60  $^{\circ}$ C or more.
- 3. Applies to output pin Vo (collector pin). Reduced to 1.5 mW/ $^{\circ}$ C at T<sub>A</sub> = 65  $^{\circ}$ C or more.
- 4. AC voltage for 1 minute at  $T_A$  = 25 °C, RH = 60 % between input and output. Pins 1-4 shorted together, 5-8 shorted together.

### **RECOMMENDED OPERATING CONDITIONS**

| Parameter                            | Symbol           | MIN. | TYP. | MAX. | Unit     |
|--------------------------------------|------------------|------|------|------|----------|
| Low Level Input Voltage              | V <sub>F</sub> L | 0    |      | 0.8  | <b>V</b> |
| High Level Input Current             | I <sub>FH</sub>  | 6.3  | 10   | 12.5 | mA       |
| Supply Voltage                       | Vcc              | 2.7  |      | 3.6  | V        |
| Pull-up Resistance                   | RL               | 330  |      | 4 k  | Ω        |
| TLL (R <sub>L</sub> = 1.0 kΩ, loads) | N                |      |      | 5    |          |

## ELECTRICAL CHARACTERISTICS (1/2) ( $T_A = -40$ to +85 °C, unless otherwise specified)

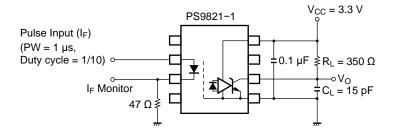
|          | Parameter Symbol Conditions                         |                                    | MIN.   | TYP.*1  | MAX.             | Unit              |     |    |
|----------|---|------------------------------------|--|---|------------------|-------------------|-----|----|
| Diode    | Forward Voltage                                     | VF                                 | I <sub>F</sub> = 10 mA, T <sub>A</sub> = 25 °C   |   | 1.4              | 1.65              | 1.8 | V  |
|          | Reverse Current                                     | lR                                 | VR = 3.0 V, TA = 25 °C   |   |                  |                   | 10  | μА |
|          | Terminal Capacitance                                | Ct                                 | V <sub>F</sub> = 0 V, f = 1 MH   | V <sub>F</sub> = 0 V, f = 1 MHz, T <sub>A</sub> = 25 °C |                  | 30                |     | pF |
| Detector | High Level Output Current                           | Іон                                | Vcc = Vo = 3.3 V,  | I <sub>F</sub> = 0.8 mA                                 |                  | 1                 | 80  | μА |
|          |   |                                    | Vcc = Vo = 5.5 V,  | I <sub>F</sub> = 0.8 mA                                 |                  | 1*2               |     |    |
|          | Low Level Output Voltage *3                         | Vol                                | Vcc = 3.3 V, I <sub>F</sub> = 5.   | 0 mA, loL = 13 mA                                       |                  | 0.2               | 0.6 | V  |
|          |   |                                    | Vcc = 5.5 V, I <sub>F</sub> = 5.   | 0 mA, lo <sub>L</sub> = 13 mA                           |                  | 0.2*2             |     |    |
|          | High Level Supply Current                           | Іссн                               | Vcc = 3.3 V, IF = 0  | mA, Vo = open   |                  | 4                 | 7   | mA |
|          | (PS9821-1)  |                                    | Vcc = 5.5 V, I <sub>F</sub> = 0  | mA, Vo = open   |                  | 5*2               |     |    |
|          | High Level Supply Current                           |                                    | Vcc = 3.3 V, I <sub>F</sub> = 0  | mA, Vo = open   |                  | 8                 | 14  |    |
|          | (PS9821-2)  |                                    | Vcc = 5.5 V, I <sub>F</sub> = 0  | mA, Vo = open   |                  | 10*2              |     |    |
|          | Low Level Supply Current                            | Iccl                               | Vcc = 3.3 V, I <sub>F</sub> = 1  | 0 mA, Vo = open   |                  | 7                 | 10  |    |
|          | (PS9821-1)  |                                    | Vcc = 5.5 V, I <sub>F</sub> = 1  | 0 mA, Vo = open   |                  | 9*2               |     |    |
|          | Low Level Supply Current                            |                                    | Vcc = 3.3 V, I <sub>F</sub> = 1  | 0 mA, Vo = open   |                  | 14                | 20  |    |
|          | (PS9821-2)  |                                    | Vcc = 5.5 V, I <sub>F</sub> = 1  | 0 mA, Vo = open   |                  | 18*²              |     |    |
| Coupled  | Threshold Input Current                             | IFHL                               | Vcc = 3.3 V, Vo =  | 0.8 V, R <sub>L</sub> = 350 Ω                           |                  | 2.5               | 5   | mA |
|          | $(H \rightarrow L)$                                 |                                    | $Vcc = 5 \text{ V}, Vo = 0.8 \text{ V}, RL = 350 \Omega$   |   |                  | 2.5* <sup>2</sup> |     |    |
|          | Isolation Resistance                                | Rı-o                               | $V_{I-O} = 1 \text{ kV}_{DC}, \text{ RH} = 40 \text{ to } 60 \text{ \%},$ $T_A = 25 \text{ °C}$  |   | 10 <sup>11</sup> |                   |     | Ω  |
|          | Insulation Resistance<br>(Input-Input), (PS9821-2)  | Rı-ı                               | V <sub>I-I</sub> = 1 kV <sub>DC</sub> , RH = T <sub>A</sub> = 25 °C  | = 40 to 60 %,   | 10 <sup>10</sup> |                   |     | Ω  |
|          | Isolation Capacitance                               | C <sub>I-O</sub>                   | V = 0 V, f = 1 MHz   | z, T <sub>A</sub> = 25 °C                               |                  | 0.6               |     | pF |
|          | Insulation Capacitance<br>(Input-Input), (PS9821-2) | Cı-ı                               | V = 0 V, f = 1 MHz   | z, T <sub>A</sub> = 25 °C                               |                  | 0.3               |     | pF |
|          | Propagation Delay Time                              | <b>t</b> PHL                       |  | T <sub>A</sub> = 25 °C                                  |                  | 45                | 75  | ns |
|          | $(H \rightarrow L)^{*4}$                            |                                    | Vcc = 3.3 V, RL = 3  | $350 \Omega$ , I <sub>F</sub> = 7.5 mA                  |                  |                   | 100 |    |
|          |   |                                    | Vcc = 5 V, RL = 35   | 0 Ω, IF = $7.5 mA$                                      |                  | 38*²              |     |    |
|          | Propagation Delay Time                              | <b>t</b> PLH                       |  | T <sub>A</sub> = 25 °C                                  |                  | 50                | 75  |    |
|          | $(L \rightarrow H)^{*4}$                            |                                    | Vcc = 3.3 V, RL = 3  | $350 \Omega$ , I <sub>F</sub> = 7.5 mA                  |                  |                   | 100 |    |
|          |   |                                    | Vcc = 5 V, RL = 35   | 0 Ω, IF = $7.5 mA$                                      |                  | 43*2              |     |    |
|          | Rise Time   | tr                                 | Vcc = 3.3 V, RL = 3  | $850  \Omega$ , I <sub>F</sub> = 7.5 mA                 |                  | 20                |     |    |
|          |   |                                    | $Vcc = 5 \text{ V}, \text{ R}_L = 350 \Omega, \text{ I}_F = 7.5 \text{ mA}$  |   |                  | 20*2              |     |    |
|          | Fall Time   | tf                                 | Vcc = 3.3 V, R <sub>L</sub> = 350 $\Omega$ , I <sub>F</sub> = 7.5 mA<br>Vcc = 5 V, R <sub>L</sub> = 350 $\Omega$ , I <sub>F</sub> = 7.5 mA |   |                  | 5                 |     |    |
|          |   |                                    |  |   |                  | 5*2               |     |    |
|          | Pulse Width Distortion (PWD) *4                     | t <sub>PLH</sub> —t <sub>PHL</sub> | $Vcc = 3.3 \text{ V}, \text{ R}_L = 350 \Omega, \text{ I}_F = 7.5 \text{ mA}$  |   |                  | 5                 | 35  |    |
|          |   |                                    | $V_{CC} = 5 \text{ V}, \text{ R}_{L} = 350 \Omega, \text{ I}_{F} = 7.5 \text{ mA}$   |   |                  | 5*2               |     |    |
|          | Propagation Delay Skew                              | <b>t</b> psk                       | $V_{CC} = 3.3 \text{ V}, \text{ RL} = 350 \Omega, \text{ IF} = 7.5 \text{ mA}$   |   |                  |                   | 40  |    |

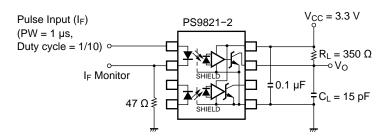
## ELECTRICAL CHARACTERISTICS (2/2) (TA = -40 to +85 °C, unless otherwise specified)

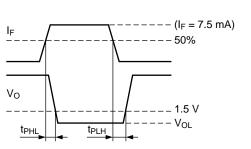
|         | Parameter                              | Symbol | Conditions  | MIN. | TYP.*1 | MAX. | Unit  |
|---------|--|--------|---|------|--------|------|-------|
| Coupled | Common Mode Transient Immunity at High | СМн    | $V_{CC} = 3.3 \text{ V}, \text{ R}_{L} = 350 \ \Omega, \text{ T}_{A} = 25 \ ^{\circ}\text{C},$ $I_{F} = 0 \text{ mA}, \text{ V}_{O} > 2 \text{ V}, \text{ V}_{CM} = 1 \text{ kV}$   | 15   | 20     |      | kV/μs |
|         | Level Output*5                         |        | $V_{CC} = 5 \text{ V}, \text{ RL} = 350 \ \Omega, \text{ T}_{A} = 25 \ ^{\circ}\text{C},$ $I_{F} = 0 \text{ mA}, \text{ Vo} > 2 \text{ V}, \text{ V}_{CM} = 1 \text{ kV}$   |      | 20*²   |      |       |
|         | Common Mode Transient Immunity at Low  | CM∟    | $\label{eq:Vcc} \begin{array}{l} \mbox{Vcc} = 3.3 \mbox{ V, RL} = 350 \ \Omega, \mbox{ T}_{\mbox{\scriptsize A}} = 25 \ ^{\circ}\mbox{C}, \\ \mbox{IF} = 7.5 \mbox{ mA, Vo} < 0.8 \mbox{ V, VcM} = 1 \mbox{ kV} \\ \end{array}$ | 15   | 20     |      |       |
|         | Level Output*5                         |        | $V_{CC} = 5 \text{ V}, \text{ RL} = 350 \ \Omega, \text{ T}_{A} = 25 \ ^{\circ}\text{C},$ $I_{F} = 7.5 \text{ mA}, \text{ Vo} < 0.8 \text{ V}, \text{ V}_{CM} = 1 \text{ kV}$   |      | 20*²   |      |       |

Notes\*: 1. Typical values at T<sub>A</sub> = 25 °C

- 2. These values are reference values.
- 3. Because VoL of 2 V or more may be output when LED current input and when output supply of Vcc = 2.6 V or less, it is important to confirm the characteristics (operation with the power supply on and off) during design, before using this device.
- 4. Test circuit for propagation delay time.

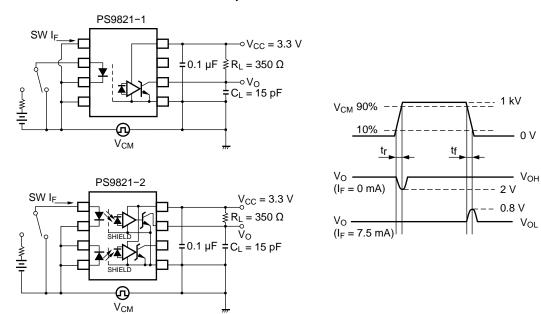






Remark: C<sub>L</sub> includes probe and stray wiring capacitance.

5. Test circuit for common mode transient immunity

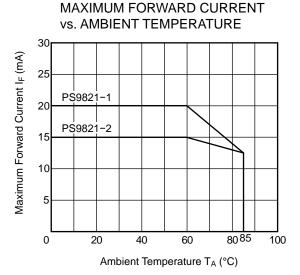


Remark: C<sub>L</sub> includes probe and stray wiring capacitance.

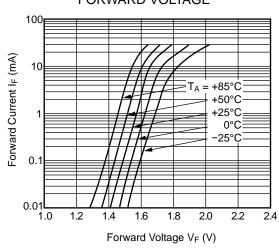
### **USAGE CAUTIONS**

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1  $\mu$ F is used between V<sub>CC</sub> and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.
- 4. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 5. Do not use fixing agents or coatings containing halogen-based substances.

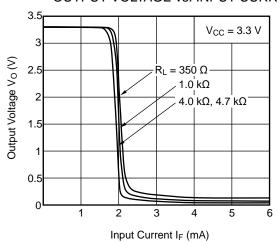
### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C unless otherwise specified)





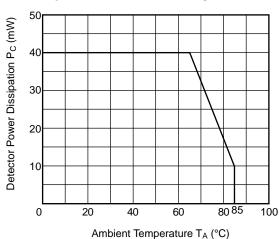


### **OUTPUT VOLTAGE vs. INPUT CURRENT**

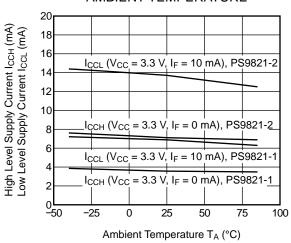


#### Remark The graphs indicate nominal characteristics.

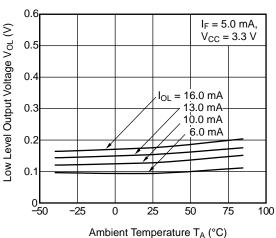




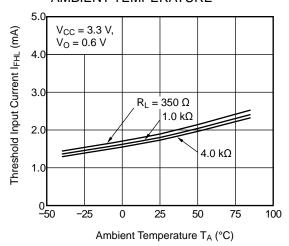
## SUPPLY CURRENT vs. AMBIENT TEMPERATURE



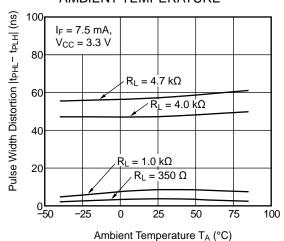
# LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



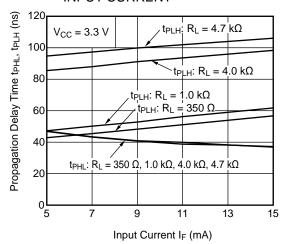
# THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



# PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE

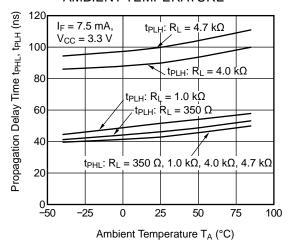


# PROPAGATION DELAY TIME vs. INPUT CURRENT

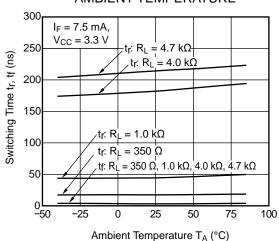


Remark The graphs indicate nominal characteristics.

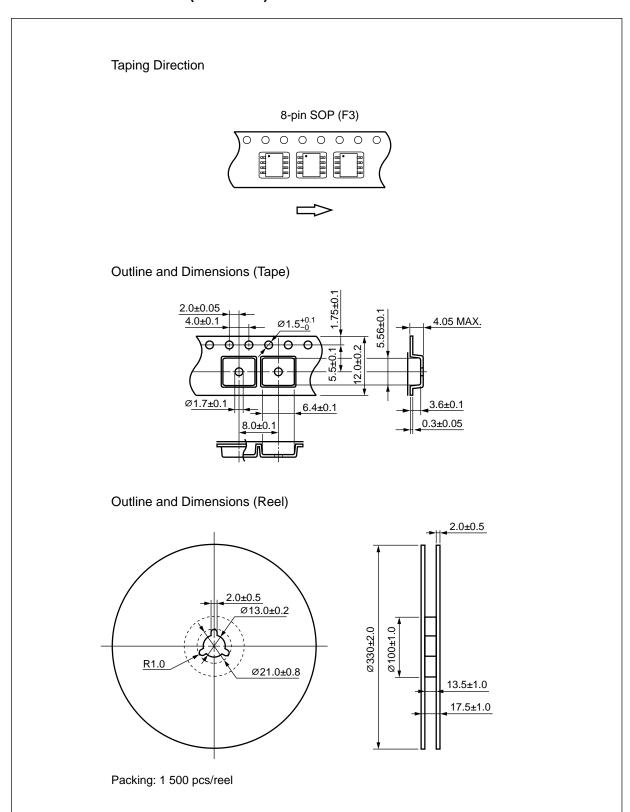
## PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE



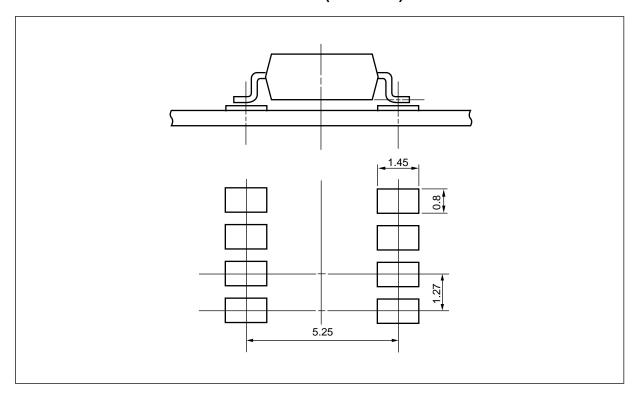
## SWITCHING TIME vs. AMBIENT TEMPERATURE



## **TAPING SPECIFICATIONS (UNIT: mm)**



## RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

### **NOTES ON HANDLING**

- 1. Recommended soldering conditions
  - (1) Infrared reflow soldering

Peak reflow temperature
 260 °C or below (package surface temperature)

Time of peak reflow temperature
 Time of temperature higher than 220 °C
 10 seconds or less
 60 seconds or less

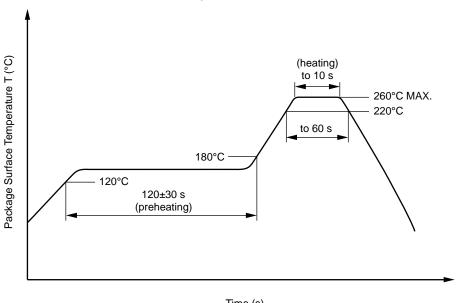
• Time to preheat temperature from 120 to 180  $^{\circ}$ C 120  $\pm$  30 s • Number of reflows

• Flux

Rosin flux containing small amount of chlorine
(The flux with a maximum chlorine content of

0.2 Wt% is recommended.)

## Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

• Temperature 260 °C or below (molten solder temperature)

• Time 10 seconds or less

• Preheating conditions 120 °C or below (package surface temperature)

Number of times
 Flux
 One (Allowed to be dipped in solder including plastic mold portion.)
 Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)
 Time (each pins)
 350 °C or below
 3 seconds or less

• Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100 °C
- (4) Cautions
  - Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

• Do not use fixing agents or coatings containing halogen-based substances.

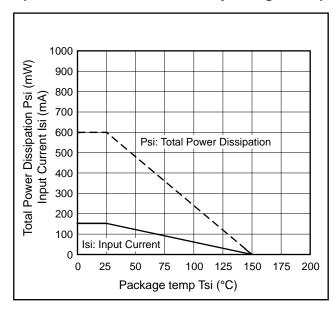
### 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

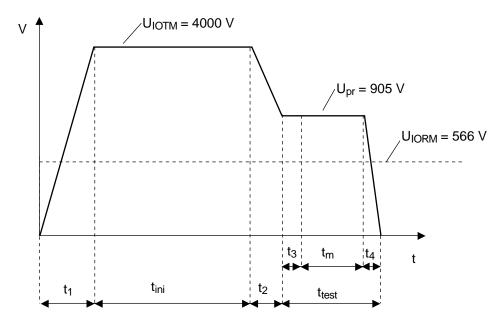
## SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter  | Symbol           | Rating           | Unit       |
|--|------------------|------------------|------------|
| Climatic test class (IEC 60068-1/DIN EN 60068-1)                                 |                  | 55/100/21        |            |
| Dielectric strength  |                  |                  |            |
| maximum operating isolation voltage  | UIORM            | 566              | $V_{peak}$ |
| Test voltage (partial discharge test, procedure a for type test and random test) | $U_pr$           | 849              | $V_{peak}$ |
| $U_{pr} = 1.6 \times U_{IORM.}, P_d < 5 pC$                                      |                  |                  |            |
| Test voltage (partial discharge test, procedure b for all devices)               | $U_pr$           | 1 061            | $V_{peak}$ |
| $U_{pr} = 1.875 \times U_{IORM.}, P_d < 5 pC$                                    |                  |                  |            |
| Highest permissible overvoltage  | U <sub>ЮТМ</sub> | 4 000            | $V_{peak}$ |
| Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))                    |                  | 2                |            |
| Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))                | CTI              | 175              |            |
| Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))                         |                  | III a            |            |
| Storage temperature range  | T <sub>stg</sub> | - 55 to +125     | °C         |
| Operating temperature range  | T <sub>A</sub>   | - 40 to +85      | °C         |
| Isolation resistance, minimum value  |                  |                  |            |
| $V_{IO}$ = 500 V dc at $T_A$ = 25 °C   | Ris MIN.         | 10 <sup>12</sup> | Ω          |
| V <sub>IO</sub> = 500 V dc at T <sub>A</sub> MAX. at least 100 °C                | Ris MIN.         | 10 <sup>11</sup> | Ω          |
| Safety maximum ratings (maximum permissible in case of fault, see thermal        |                  |                  |            |
| derating curve)  |                  |                  |            |
| Package temperature  | Tsi              | 150              | °C         |
| Current (input current I <sub>F</sub> , Psi = 0)                                 | Isi              | 150              | mA         |
| Power (output or total power dissipation)  | Psi              | 600              | mW         |
| Isolation resistance   |                  |                  |            |
| $V_{IO} = 500 \text{ V dc at T}_A = Tsi$   | Ris MIN.         | 10 <sup>9</sup>  | Ω          |

## Dependence of maximum safety ratings with package temperature



## Method a) Destructive Test, Type and Sample Test



 $t_1$ ,  $t_2 = 1$  to 10 sec

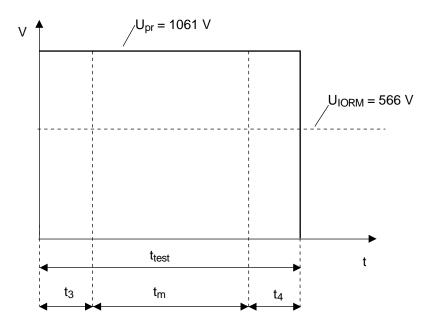
 $t_3, t_4 = 1 sec$ 

 $t_{m(PARTIAL\ DISCHARGE)} = 10\ sec$ 

 $t_{\text{test}} = 12 \text{ sec}$ 

 $t_{ini} = 60 sec$ 

## Method b) Non-destructive Test, 100% Production Test



 $t_3$ ,  $t_4 = 0.1 \text{ sec}$ 

 $t_{\text{m(PARTIAL DISCHARGE)}} = 1.0 \text{ sec}$ 

 $t_{test} = 1.2 \text{ sec}$ 

#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or i any way allow it to enter the mouth.

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